
Device and Emerging Technologies WG

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- Metrics for interconnect technologies
 - > Cost/bit/sec
 - > Energy/bit
 - > Density (bits/sec, per chip, etc.)

Interconnect domains

- On-chip global (cm)
- On-module (cm)
- On board (20cm)
- Intra-cabinet (0.5-1m)
- Inter-cabinet (2-50m)

**WG Plan: examine key emerging technologies
at multiple domains, evaluate challenges,
impact**

Key Emerging Technologies

- CMOS – aggressive scaling as benchmark
- Silicon Photonics
- Proximity Communications
 - > Capacitive, inductive
- MEMS
- 3-D integration
- Speculative: RF, free-space optics, CNTs

Electrical Signaling Near-term Potentials

- On-chip (cm) ~1 pJ/bit, 100 Tb/s
- On-module (cm) ~2-5 pJ/bit, 1-10 Tb/s per chip
- On board (20cm) ~5-10 pJ/bit, 1-5 Tb/s per module
- Intra-cabinet (0.5-1m) ~10-15 pJ/bit, 1-5 Tb/s per board
- Inter-cabinet (2-50m) ~20-30 pJ/bit, 5-10 Tb/s per cabinet (optical)
- **1pJ → 1MW @ EB/s**

Challenges of Silicon Photonics

- **Device-Level**
 - > Novel WDM devices, switches, modulators, receivers
 - > Integration density
 - > low optical loss
 - > Thermal stability
 - > manufacturability
- **Circuit-Level**
 - > Analog circuits in scaled CMOS (voltage headroom, variations,etc.)
 - > reliability
 - > Energy
 - > E/O interface
- **System-Level**
 - > Optical packaging
 - > Connectors
 - > Chip-scale packaging (photonics/electronics)
 - > reliability

Critical Off-chip Boundaries

- **Intra-node processor-memory interface**
- **Inter-node**

Maturity/impact/cost

Technical	Maturity			Impact/Rewards			NRE (cost)		
	High	Med	Low	High	Med	Low	High	Med	Low
Intra-node processor-memory interface									
CMOS photonics			x	x			x		
3-D stacking (parallel and orthogonal)	x			x				x	
proximity Comm.	x			x				x	
Inter-node									
dense integrated-photonics to fiber interface	x			x				x	
CMOS photonics			x	x			x		
Packaging (E&O)	x			x			x		
Switching									
optical switching	x				x		x		
MEMS	x				x				x
hybrid (electrical/optical)		x		?	x			x	